

Substitute for form 1449A/PTO

**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**

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Sheet 1

of

2

Complete if Known

Application Number	09/808,067
Filing Date	March 14, 2001
First Named Inventor	Abbott et al.
Group Art Unit	2505
Examiner Name	Jarrot, Scott L.
Attorney Docket Number	YOR92000681US1

U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No. ¹	U.S. Patent Document		Name of Patentee or Applicant/Inventor of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
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OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published	²
		IBM Watson Implosion Technology Release 6.0, User's Guide and Reference, April 17, 2006-Draft Document, Second Edition (March 2000), 410 pages total	
		Gupta, et al., "An Optimization Approach for A Reverse Logistics Supply Chain," Proceedings of the International Group Technology and Cellular Manufacturing Conference, 2000, pp. 1-6	
		Veerakamolmal, P., "DESIGN AND ANALYSIS OF DISASSEMBLY AND REMANUFACTURING SYSTEMS IN THE ELECTRONICS INDUSTRY," UMI Microform 9937438, Copyright 1999, June 1999, pp. 1-118	
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		Veerakamolmal, et al., "Design of an Integrated Component Recovery System," Proceedings of the 1998 IEEE International Symposium on Electronics and the Environment, May 4-6, pp. 264-269	
		Veerakamolmal, et al., "High-mix/Low-volume Batch of Electronic Equipment Disassembly," Computers and Industrial Engineering, Vol. 35(1-2), pp. 65-68	

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		Veerakamolmal, et al., "Optimal Analysis of Lot-Size Balancing for Multiproducts Selective Disassembly," International Journal of Flexible Automation and Integrated Manufacturing, Vol. 6(3&4), 1998, pp. 245-269	
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		Veerakamolmal, et al., "ANALYSIS OF DESIGN EFFICIENCY FOR THE DISASSEMBLY OF MODULAR ELECTRONIC PRODUCTS," Journal of Electronics Manufacturing, Vol. 9, No. 1, March 1999, pp. 79-95	
		Veerakamolmal, et al., "Disassembly," Industrial Engineering Encyclopedia, 6 pages	
		Veerakamolmal, et al., "Disassembly Process Planning," International Conference on Engineering Design and Automation, March 18-21, 4 pages	

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